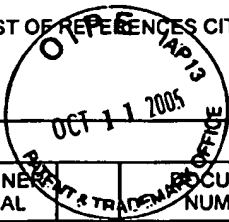


Form PTO 1449 (Modified)		U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE		ATTY DOCKET NO. 210679US2SRD		SERIAL NO. 09/893,874	
LIST OF REFERENCES CITED BY APPLICANT 				APPLICANT Hideki KOBAYASHI, et al.			
				FILING DATE June 29, 2001		GROUP 2123	
				U.S. PATENT DOCUMENTS			
EXAMINER INITIAL	DOCUMENT NUMBER	DATE	NAME	CLASS	SUB CLASS	FILING DATE IF APPROPRIATE	
AA							
AB							
AC							
AD							
AE							
AF							
AG							
AH							
AI							
AJ							
AK							
AL							
AM							
AN							
FOREIGN PATENT DOCUMENTS							
		DOCUMENT NUMBER	DATE	COUNTRY	TRANSLATION		
					YES	NO	
<i>Appl</i>	AO	11-288427	10/19/1999	Japan (with English abstract)		X	
<i>Appl</i>	AP	63-144937	6/17/1988	Japan (with English abstract)		X	
<i>Appl</i>	AQ	11-267951	10/5/1999	Japan (with English abstract)		X	
<i>Appl</i>	AR	11-3101	1/6/1999	Japan (with English abstract)		X	
<i>Appl</i>	AS	5-314094	11/26/1993	Japan (with English abstract)		X	
	AT						
	AU						
	AV						
OTHER REFERENCES (Including Author, Title, Date, Pertinent Pages, etc.)							
	AW	Tomioka et al., "IT Utilization Strategy for Each Product and Attracted Company: Aim at Adoption to Lifetime Reduction, Cost Reduction and Parts Recycle," Nikkei Digital Engineering, Japan, Nikkei Business Publications, Inc., January 15, 2000, No. 26, pp. 104-111.					
	AX	Watanabe et al., "Technique for Recycling Parts of Copying Machine," Nikkei Mechanical, Japan, Nikkei Business Publications Inc., September 8, 1997, No. 514, pp. 22-23.					
	AY	Kimura, "Inverse Manufacturing," IEEE Journal, Japan, The Institute of Electronics, Information and Communication Engineers, August 25, 1997, Vol. 80, No. 8, pp. 791-797.					
	AZ					<input type="checkbox"/> Additional References sheet(s) attached	
Examiner <i>Appl Shw...</i>				Date Considered <i>10/24/05</i>			
*Examiner: Initial if reference is considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.							

Not
in
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